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## FDC610PZ P-Channel PowerTrench<sup>®</sup> MOSFET –30V, –4.9A, 42mΩ Features

- Max r<sub>DS(on)</sub> = 42mΩ at V<sub>GS</sub> = -10V, I<sub>D</sub> = -4.9A
- Max  $r_{DS(on)}$  = 75m $\Omega$  at V<sub>GS</sub> = -4.5V, I<sub>D</sub> = -3.7A
- Low gate charge (17nC typical).
- High performance trench technology for extremely low r<sub>DS(on)</sub>.
- SuperSOT<sup>TM</sup> –6 package: small footprint (72% smaller than standard SO–8) low profile (1mm thick).
- RoHS Compliant

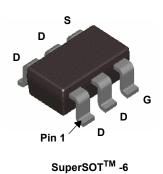
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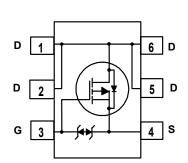
## General Description

This P-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance. These devices are well suited for battery power applications: load switching and power management, battery charging circuits, and DC/DC conversion.

### Application

DC - DC Conversion





### MOSFET Maximum Ratings TA= 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage		-30	V
V <sub>GS</sub>	Gate to Source Voltage		±25	V
1	Drain Current -Continuous	(Note 1a)	-4.9	•
D	-Pulsed		-20	A
D	Power Dissipation	(Note 1a)	1.6	W
P <sub>D</sub>	Power Dissipation	(Note 1b)	0.8	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	156	C/vv

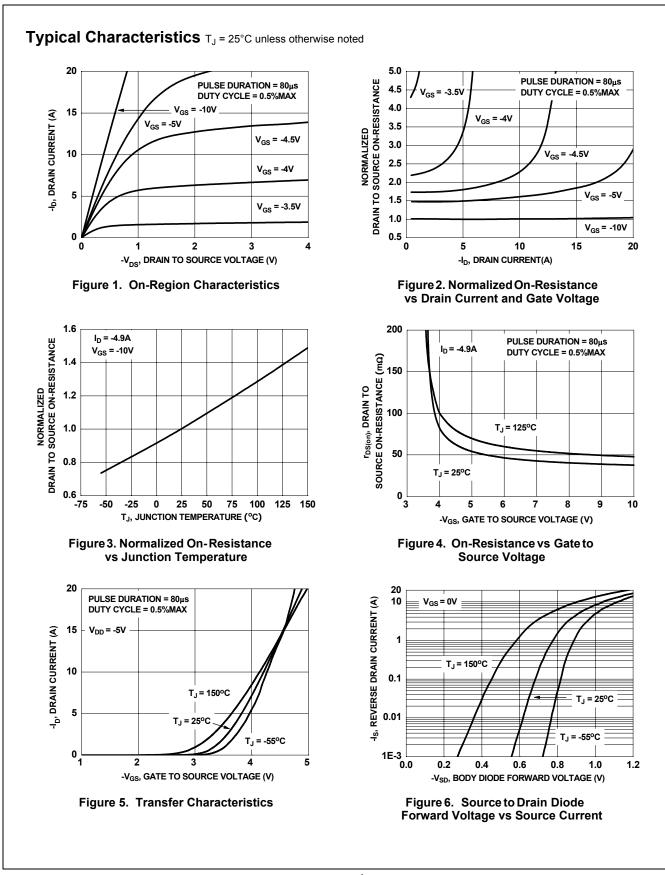
#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
.610Z	FDC610PZ	SSOT6	7"	8mm	3000units

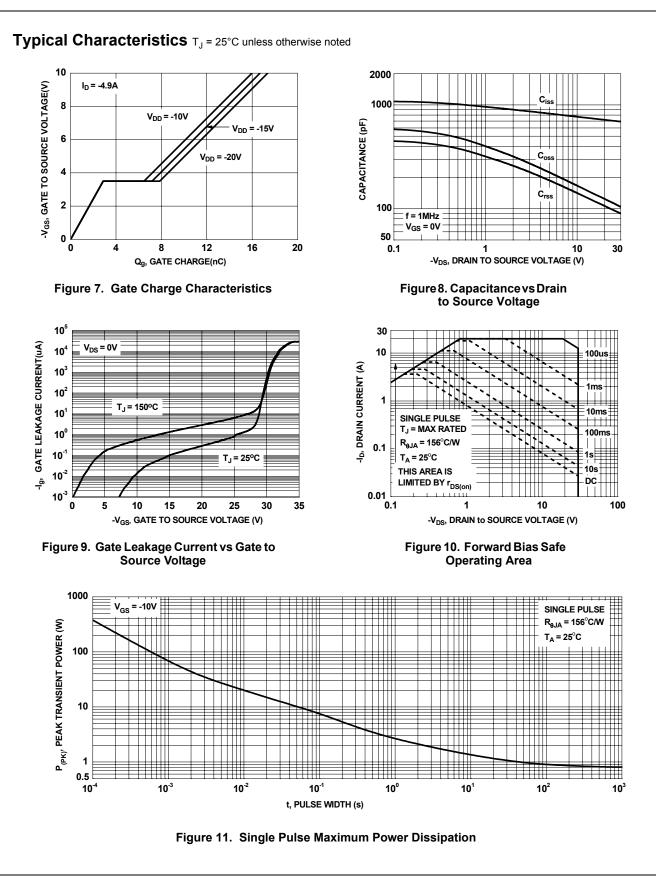
Symbol Off Charao BV <sub>DSS</sub> $\Delta$ BV <sub>DSS</sub> $\Delta$ T <sub>J</sub> I <sub>DSS</sub> I <sub>GSS</sub> On Charao	Cteristics Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient			Тур		Units
BV <sub>DSS</sub> ΔBV <sub>DSS</sub> ΔT <sub>J</sub> I <sub>DSS</sub> I <sub>GSS</sub>	Drain to Source Breakdown Voltage Breakdown Voltage Temperature					
ΔBV <sub>DSS</sub> ΔT <sub>J</sub> I <sub>DSS</sub> I <sub>GSS</sub>	Breakdown Voltage Temperature	I <sub>D</sub> = –250μA, V <sub>GS</sub> = 0V	-30			V
I <sub>DSS</sub> I <sub>GSS</sub>		$I_D = -250\mu$ A, referenced to 25°C		-22		mV/°C
I <sub>GSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -24V, V_{GS} = 0V$			-1	μA
	Gate to Source Leakage Current	$V_{GS} = \pm 25V, V_{DS} = 0V$			±10	μA
On Charac		63 7, 53				1
N/			1	2.2	2	V
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = -250 \mu A$	–1	-2.2	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250\mu A$ , referenced to 25°C		6		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = -10V, I_D = -4.9A$		36	42	mΩ
r <sub>DS(on)</sub>		$V_{GS} = -4.5V, I_D = -3.7A$		58	75	
		$V_{GS} = -10V, I_D = -4.9A, T_J = 125^{\circ}C$		50	60	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = -10V, I_D = -4.9A$		15		S
Dynamic (	Characteristics					
C <sub>iss</sub>	Input Capacitance			755	1005	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = -15V, V_{GS} = 0V,$		145	195	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		125	190	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		13		Ω
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = -15V, I <sub>D</sub> = -4.9A		7	14 10	ns
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	-V <sub>DD</sub> = -15V, I <sub>D</sub> = -4.9A -V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω			14 10 53	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time			4	10	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS} = -10V, R_{GEN} = 6\Omega$		4 33	10 53	ns ns
t <sub>d(on)</sub> t <u>r</u> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$		4 33 23	10 53 37	ns ns ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$		4 33 23 17	10 53 37 24	ns ns ns nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = -10V, R_{GEN} = 6\Omega$		4 33 23 17 9	10 53 37 24	ns ns ns nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge	$V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$		4 33 23 17 9 2.9	10 53 37 24	ns ns nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-Sou</b>	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate ChargeTotal Gate ChargeGate to Source Gate Charge	$V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$ $V_{GS} = 0V \text{ to } -4.5V$ $V_{DD} = -15V,$ $I_D = -4.9A$		4 33 23 17 9 2.9	10 53 37 24	ns ns nC nC nC
- t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gg</sub> Q <sub>gd</sub> <b>Drain-Sou</b> Is	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge <b>rce Diode Characteristics</b>	$V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$ $V_{GS} = 0V \text{ to } -4.5V$ $V_{DD} = -15V,$ $I_{D} = -4.9A$ ende Forward Current		4 33 23 17 9 2.9	10 53 37 24 13	ns ns nC nC nC nC
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub> <b>Drain-Sou</b>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Gate Charge Gate to Drain "Miller" Charge <b>rce Diode Characteristics</b> Maximum Continuous Drain-Source Dio	$V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$ $V_{GS} = 0V \text{ to } -4.5V$ $V_{DD} = -15V,$ $I_{D} = -4.9A$ ende Forward Current		4 33 23 17 9 2.9 4.3	10 53 37 24 13 -1.3	ns ns nC nC nC nC

2. Pulse Test: Pulse Width < 300 $\mu$ s, Duty cycle < 2.0%.

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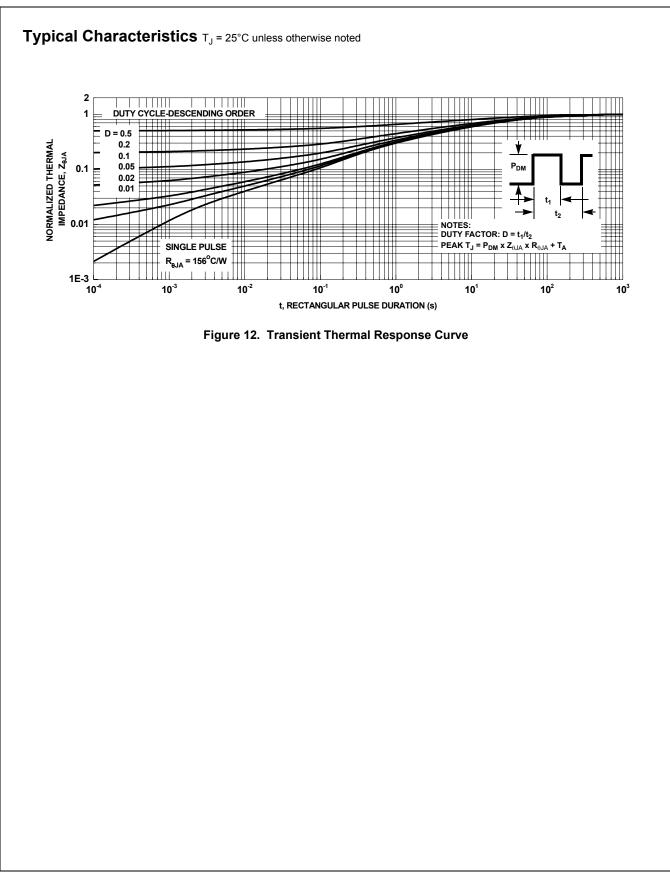


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